502868855 06/26/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHANG-CHIEH CHIEN	03/03/2014
SHU-HAO CHANG	03/03/2014
HSIANG-YU CHOU	03/03/2014
MING-CHIN CHIEN	03/03/2014
JUI-CHING WU	03/03/2014
JENG-HORNG CHEN	03/11/2014

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	NO. 8, LI-HSIN RD. 6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300-77

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14186818

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ATTORNEY DOCKET NUMBER:	24061.2779
NAME OF SUBMITTER:	DENISE M. WILSON
SIGNATURE:	/Denise M. Wilson/
DATE SIGNED:	06/26/2014

502868855 PATENT REEL: 033186 FRAME: 0679

Total Attachments: 3 source=2779-assignment#page1.tif source=2779-assignment#page2.tif source=2779-assignment#page3.tif

PATENT REEL: 033186 FRAME: 0680 echiend 2014-03-03 10:31:55

Docket No.: 2013-1885 /24061,2779

Customer No.: 000042717

ASSIGNMENT

WHEREAS, we,

(1)	Shang-Chieh Chien	of	2F., No.8, Lane, 113, Section 3, Sanhe Road, Sanchong District, New Taipei City 241, Taiwan R.O.C.
(2)	Shu-Hao Chang	of	3F., No.229, Raohe Street Songshan District, Taipei City 105 Taiwan R.O.C.
(3)	Hsiang-Yu Chou	of	1F, No. 16, Ln. 6, Yongkang Street Taipei, 106, Taiwan R.O.C.
(4)	Ming-Chin Chien	of	No. 52, Jinshan E. 3rd Street East District, Hsinchu City 300 Taiwan R.O.C.
(5)	Jui-Ching Wu	of	10F., No.223, Bade Road East District, Hsinchu City 300 Taiwan R.O.C.
(6)	Jeng-Horng Chen	of	1, Alley 2, Lane 45, Fu-Chyun Street Hsin-Chu, Taiwan, R.O.C.

have invented certain improvements in

METHOD FOR LITHOGRAPHY PATTERNING

for which we have filed an application for Letters Patent of the United States of America on February 21, 2014, as U.S. Serial No. 14/186,818; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the

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Docket No.: 2013-1885 /24061.2779

Customer No.: 000042717

above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:	Shang-Chieh Chien	
Residence Address:	2F., No.8, Lane, 113, Section 3, Sanhe Road, Sanchong District New Taipei City 241, Taiwan R.O.C.	
Dated: 2014, 3,	3	Shang-Chieh Chien. Inventor Signature
Inventor Name:	Shu-Hao Chang	

Dated: 2014, 3, 5

Inventor Signature Mang

Inventor Name:

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Hsiang-Yu Chou

Taiwan R.O.C.

Residence Address:

Residence Address:

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Dated: 2014. 3. 3

Hsiang - Yn Chon Inventor Signature

Docket No.: 2013-1885 /24061.2779

Customer No.: 000042717

Inventor Name:

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Inventor Signature

Inventor Name:

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Dated: 2014, 3,3

Jui-Ching Vu.
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Inventor Name:

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Dated:

Liventor Signature

R-2779 - Updated Assignment

RECORDED: 06/26/2014

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